

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	296	(second! or another or addition\$6) near2 (nozzle\$3 or input\$3 or port\$3) near4 ((react\$4 near2 (gas or reactant)) or ("SiH.sub.4" or "SiF.sub.4" or TEOS))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:24
2	L2	215	1 and ((@ad<"20000418") or (@rlad<"20000418"))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:39
3	L3	180	2 and (delay or after or pause or continu\$6)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:24
4	L4	74	3 and (center or middle or mid or midpoint)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:34

	L #	Hits	Search Text	DBs	Time Stamp
5	L5	96	(initial near2 (film or layer)) near8 (center or middle or midpoint or mid)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:35
6	L6	54	5 and ((@ad<"20000418") or (@rlad<"20000418"))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:36
7	L7	3	6 and (nozzle or orifice)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:37
8	L8	1500	(center or mid or middle or midpoint) with (film layer) with (nozzle or orifice)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:38

	L #	Hits	Search Text	DBs	Time Stamp
9	L9	475	8 with (wafer or substrate or holder or carrier or board)	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:39
10	L10	225	9 and ((@ad<"20000418") or (@rlad<"20000418"))	US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/02/10 19:39